

74AHC2G32; 74AHCT2G32

Dual 2-input OR gate

Rev. 01 — 23 February 2004

Product data sheet

1. General description

The 74AHC2G/AHCT2G32 is a high-speed Si-gate CMOS device. This device provides two 2-input OR gates.

2. Features

- Symmetrical output impedance
- High noise immunity
- ESD protection:
 - ◆ HBM EIA/JESD22-A114-A exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V
 - ◆ CDM EIA/JESD22-C101 exceeds 1000 V.
- Low power dissipation
- Balanced propagation delays
- SOT505-2 and SOT765-1 package
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$.

3. Quick reference data

Table 1: Quick reference data

$GND = 0\text{ V}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$; $t_r = t_f \leq 3.0\text{ ns}$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------------|--------------------------------------|---|--------|-----|-----|------|
| Type 74AHC2G | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA and nB to nY | $C_L = 15\text{ pF}$; $V_{CC} = 5\text{ V}$ | - | 3.2 | 5.5 | ns |
| C_I | input capacitance | | - | 1.5 | 10 | pF |
| C_{PD} | power dissipation capacitance | $C_L = 50\text{ pF}$; $f_i = 1\text{ MHz}$ | [1][2] | 16 | - | pF |
| Type 74AHCT2G | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA and nB to nY | $C_L = 15\text{ pF}$; $V_{CC} = 5\text{ V}$ | - | 3.3 | 6.9 | ns |
| C_I | input capacitance | | - | 1.5 | 10 | pF |
| C_{PD} | power dissipation capacitance | $C_L = 50\text{ pF}$; $f_i = 1\text{ MHz}$ | [1][2] | 17 | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

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C_L = output load capacitance in pF;
 V_{CC} = supply voltage in Volts;
 N = total load switching outputs;
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[2] The condition is $V_I = GND$ to V_{CC} .

4. Ordering information

Table 2: Ordering information

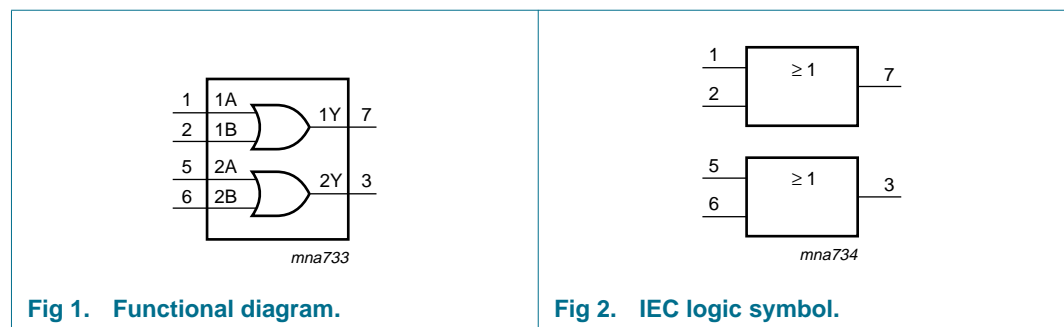
| Type number | Package | | | Version |
|--------------|-------------------|--------|---|----------|
| | Temperature range | Name | Description | |
| 74AHC2G32DP | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 |
| 74AHCT2G32DP | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 |
| 74AHC2G32DC | -40 °C to +125 °C | VSSOP8 | plastic very shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |
| 74AHCT2G32DC | -40 °C to +125 °C | VSSOP8 | plastic very shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |

5. Marking

Table 3: Marking

| Type number | Marking code |
|--------------|--------------|
| 74AHC2G32DP | A32 |
| 74AHCT2G32DP | C32 |
| 74AHC2G32DC | A32 |
| 74AHCT2G32DC | C32 |

6. Functional diagram



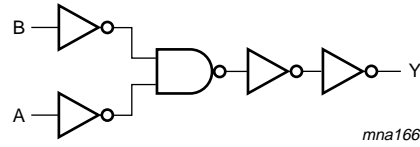


Fig 3. Logic diagram (logic driver).

7. Pinning information

7.1 Pinning

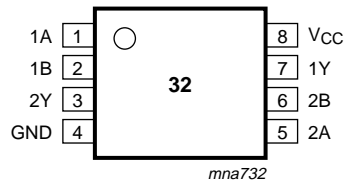


Fig 4. Pin configuration.

7.2 Pin description

Table 4: Pin description

| Pin | Symbol | Description |
|-----|-----------------|----------------|
| 1 | 1A | data input |
| 2 | 1B | data input |
| 3 | 2Y | data output |
| 4 | GND | ground (0 V) |
| 5 | 2A | data input |
| 6 | 2B | data input |
| 7 | 1Y | data output |
| 8 | V _{CC} | supply voltage |

8. Functional description

8.1 Function table

Table 5: Function table ^[1]

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | L |
| L | H | H |
| H | L | H |
| H | H | H |

[1] H = HIGH voltage level;
L = LOW voltage level.

9. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-------------------|-------------------------------|---|------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| V_I | input voltage | | -0.5 | +7.0 | V |
| I_{IK} | input diode current | $V_I < -0.5$ V | - | -20 | mA |
| I_{OK} | output diode current | $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V ^[1] | - | ±20 | mA |
| I_O | output source or sink current | $V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V | - | ±25 | mA |
| I_{CC}, I_{GND} | V_{CC} or GND current | | - | ±75 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | power dissipation | $T_{amb} = -40$ °C to +125 °C | - | 250 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 7: Recommended operating operations

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------|--|-----|-----|----------|------|
| Type 74AHC2G | | | | | | |
| V_{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | operating ambient temperature | see Section 11 and Section 12 per device | -40 | +25 | +125 | °C |

Table 7: Recommended operating operations ...continued

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------------|-------------------------------|--|-----|-----|----------|------|
| t_r, t_f | input rise and fall times | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | - | - | 100 | ns/V |
| | | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ | - | - | 20 | ns/V |
| Type 74AHCT2G | | | | | | |
| V_{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | operating ambient temperature | see Section 11 and Section 12 per device | -40 | +25 | +125 | °C |
| t_r, t_f | input rise and fall times | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ | - | - | 20 | ns/V |

11. Static characteristics

Table 8: Static characteristics type 74AHC2G32

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---------------------------|--|------|-----|------|---------------|
| $T_{amb} = 25 \text{ °C}$ | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.0 \text{ V}$ | 1.5 | - | - | V |
| | | $V_{CC} = 3.0 \text{ V}$ | 2.1 | - | - | V |
| | | $V_{CC} = 5.5 \text{ V}$ | 3.85 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.0 \text{ V}$ | - | - | 0.5 | V |
| | | $V_{CC} = 3.0 \text{ V}$ | - | - | 0.9 | V |
| | | $V_{CC} = 5.5 \text{ V}$ | - | - | 1.65 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -50 \text{ } \mu\text{A}; V_{CC} = 2.0 \text{ V}$ | 1.9 | 2.0 | - | V |
| | | $I_O = -50 \text{ } \mu\text{A}; V_{CC} = 3.0 \text{ V}$ | 2.9 | 3.0 | - | V |
| | | $I_O = -50 \text{ } \mu\text{A}; V_{CC} = 4.5 \text{ V}$ | 4.4 | 4.5 | - | V |
| | | $I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.58 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 50 \text{ } \mu\text{A}; V_{CC} = 2.0 \text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 50 \text{ } \mu\text{A}; V_{CC} = 3.0 \text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 50 \text{ } \mu\text{A}; V_{CC} = 4.5 \text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | V |
| I_{LI} | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | 0.1 | μA |
| | | $V_{CC} = 5.5 \text{ V}$ | - | - | 1.0 | μA |
| C_I | input capacitance | | - | 1.5 | 10 | pF |

Table 8: Static characteristics type 74AHC2G32 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--|---|------|------|------|---------------|
| $T_{amb} = -40\text{ °C to }+85\text{ °C}$ | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.0\text{ V}$ | 1.5 | - | - | V |
| | | $V_{CC} = 3.0\text{ V}$ | 2.1 | - | - | V |
| | | $V_{CC} = 5.5\text{ V}$ | 3.85 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.0\text{ V}$ | - | - | 0.5 | V |
| | | $V_{CC} = 3.0\text{ V}$ | - | - | 0.9 | V |
| | | $V_{CC} = 5.5\text{ V}$ | - | - | 1.65 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 2.0\text{ V}$ | 1.9 | - | - | V |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 3.0\text{ V}$ | 2.9 | - | - | V |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 4.5\text{ V}$ | 4.4 | - | - | V |
| | | $I_O = -4.0\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | 2.48 | - | - | V |
| | $I_O = -8.0\text{ mA}$; $V_{CC} = 4.5\text{ V}$ | 3.8 | - | - | V | |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 50\text{ }\mu\text{A}$; $V_{CC} = 2.0\text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 50\text{ }\mu\text{A}$; $V_{CC} = 3.0\text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 50\text{ }\mu\text{A}$; $V_{CC} = 4.5\text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 4.0\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | - | - | 0.44 | V |
| | $I_O = 8.0\text{ mA}$; $V_{CC} = 4.5\text{ V}$ | - | - | 0.44 | V | |
| I_{LI} | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5\text{ V}$ | - | - | 1.0 | μA |
| I_{CC} | quiescent supply current | $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$; $V_{CC} = 5.5\text{ V}$ | - | - | 10 | μA |
| C_I | input capacitance | | - | - | 10 | pF |
| $T_{amb} = -40\text{ °C to }+125\text{ °C}$ | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.0\text{ V}$ | 1.5 | - | - | V |
| | | $V_{CC} = 3.0\text{ V}$ | 2.1 | - | - | V |
| | | $V_{CC} = 5.5\text{ V}$ | 3.85 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.0\text{ V}$ | - | - | 0.5 | V |
| | | $V_{CC} = 3.0\text{ V}$ | - | - | 0.9 | V |
| | | $V_{CC} = 5.5\text{ V}$ | - | - | 1.65 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 2.0\text{ V}$ | 1.9 | - | - | V |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 3.0\text{ V}$ | 2.9 | - | - | V |
| | | $I_O = -50\text{ }\mu\text{A}$; $V_{CC} = 4.5\text{ V}$ | 4.4 | - | - | V |
| | | $I_O = -4.0\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | 2.40 | - | - | V |
| | $I_O = -8.0\text{ mA}$; $V_{CC} = 4.5\text{ V}$ | 3.70 | - | - | V | |

Table 8: Static characteristics type 74AHC2G32 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------|--------------------------|---|-----|-----|------|---------------|
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | - | - | - | - |
| | | $I_O = 50 \mu\text{A}$; $V_{CC} = 2.0 \text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 50 \mu\text{A}$; $V_{CC} = 3.0 \text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 50 \mu\text{A}$; $V_{CC} = 4.5 \text{ V}$ | - | - | 0.1 | V |
| | | $I_O = 4.0 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | V |
| | | $I_O = 8.0 \text{ mA}$; $V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | V |
| I_{LI} | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | 2.0 | μA |
| I_{CC} | quiescent supply current | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$; $V_{CC} = 5.5 \text{ V}$ | - | - | 40 | μA |
| C_I | input capacitance | | - | - | 10 | pF |

Table 9: Static characteristics type 74AHCT2G32

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|------|-----|------|---------------|
| $T_{amb} = 25 \text{ }^\circ\text{C}$ | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | - | - | - | - |
| | | $I_O = -50 \mu\text{A}$; $V_{CC} = 4.5 \text{ V}$ | 4.4 | 4.5 | - | V |
| | | $I_O = -8.0 \text{ mA}$; $V_{CC} = 4.5 \text{ V}$ | 3.94 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | - | - | - | - |
| | | $I_O = 50 \mu\text{A}$; $V_{CC} = 4.5 \text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 8.0 \text{ mA}$; $V_{CC} = 4.5 \text{ V}$ | - | - | 0.36 | V |
| I_{LI} | input leakage current | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5 \text{ V}$ | - | - | 0.1 | μA |
| I_{CC} | quiescent supply current | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$; $V_{CC} = 5.5 \text{ V}$ | - | - | 1.0 | μA |
| ΔI_{CC} | additional quiescent supply current per input pin | $V_I = 3.4 \text{ V}$; other inputs at V_{CC} or GND; $I_O = 0 \text{ A}$; $V_{CC} = 5.5 \text{ V}$ | - | - | 1.35 | mA |
| C_I | input capacitance | | - | 1.5 | 10 | pF |
| $T_{amb} = -40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$ | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | - | - | - | - |
| | | $I_O = -50 \mu\text{A}$; $V_{CC} = 4.5 \text{ V}$ | 4.4 | - | - | V |
| | | $I_O = -8.0 \text{ mA}$; $V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | V |

Table 9: Static characteristics type 74AHCT2G32 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---|--|------|-----|------|------|
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} I _O = 50 μA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.44 | V |
| I _{LI} | input leakage current | V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V | - | - | 1.0 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 10 | μA |
| ΔI _{CC} | additional quiescent supply current per input pin | V _I = 3.4 V; other inputs at V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 1.5 | mA |
| C _I | input capacitance | | - | - | 10 | pF |
| T_{amb} = -40 °C to +125 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} I _O = -50 μA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.70 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} I _O = 50 μA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.55 | V |
| I _{LI} | input leakage current | V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V | - | - | 2.0 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 40 | μA |
| ΔI _{CC} | additional quiescent supply current per input pin | V _I = 3.4 V; other inputs at V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 1.5 | mA |
| C _I | input capacitance | | - | - | 10 | pF |

12. Dynamic characteristics

Table 10: Dynamic characteristics type 74AHC2G32

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $t_r = t_f \leq 3.0$ ns; see [Figure 6](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--------------------------------------|--|-----------|-----|------|------|
| $T_{amb} = 25$ °C | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA and nB to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 15$ pF | [1] - | 4.4 | 7.9 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | [2] - | 3.2 | 5.5 | ns |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 50$ pF | - | 6.3 | 11.4 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | - | 4.6 | 7.5 | ns |
| C_{PD} | power dissipation capacitance | $C_L = 50$ pF; $f_i = 1$ MHz | [3] [4] - | 16 | - | pF |
| $T_{amb} = -40$ °C to $+85$ °C | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA and nB to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 15$ pF | 1.0 | - | 9.5 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | 1.0 | - | 6.5 | ns |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 50$ pF | 1.0 | - | 13.0 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | 1.0 | - | 8.5 | ns |
| $T_{amb} = -40$ °C to $+125$ °C | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA and nB to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 15$ pF | 1.0 | - | 10.0 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | 1.0 | - | 7.0 | ns |
| | | $V_{CC} = 3.0$ V to 3.6 V; $C_L = 50$ pF | 1.0 | - | 14.5 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | 1.0 | - | 9.5 | ns |

[1] Typical values are measured at $V_{CC} = 3.3$ V.

[2] Typical values are measured at $V_{CC} = 5.0$ V.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[4] The condition is $V_i = \text{GND}$ to V_{CC} .

Table 11: Dynamic characteristics type 74AHCT2G32

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $t_r = t_f \leq 3.0$ ns; see [Figure 6](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--------------------------------------|--|-----------|-----|------|------|
| $T_{amb} = 25$ °C | | | | | | |
| t_{PHL}, t_{PLH} | propagation delay nA and nB to nY | see Figure 5 $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | [1] - | 3.3 | 6.9 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | [1] - | 4.8 | 7.9 | ns |
| C_{PD} | power dissipation capacitance | $C_L = 50$ pF; $f_i = 1$ MHz | [2] [3] - | 17 | - | pF |
| $T_{amb} = -40$ °C to $+85$ °C | | | | | | |
| t_{PHL}, t_{PLH} | propagation delay nA and nB to nY | see Figure 5 $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | 1.0 | - | 8.0 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | 1.0 | - | 9.0 | ns |
| $T_{amb} = -40$ °C to $+125$ °C | | | | | | |
| t_{PHL}, t_{PLH} | propagation delay nA and nB to nY | see Figure 5 $V_{CC} = 4.5$ V to 5.5 V; $C_L = 15$ pF | 1.0 | - | 9.0 | ns |
| | | $V_{CC} = 4.5$ V to 5.5 V; $C_L = 50$ pF | 1.0 | - | 10.0 | ns |

[1] Typical values are measured at $V_{CC} = 5.0$ V.

[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

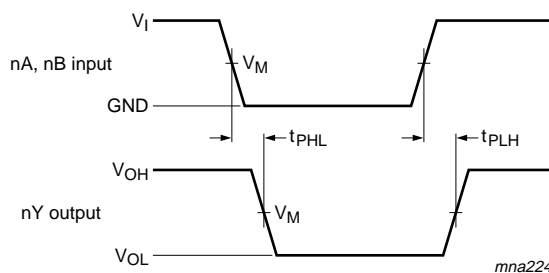
V_{CC} = supply voltage in Volts;

N = total load switching outputs;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[3] The condition is $V_i = \text{GND to } V_{CC}$.

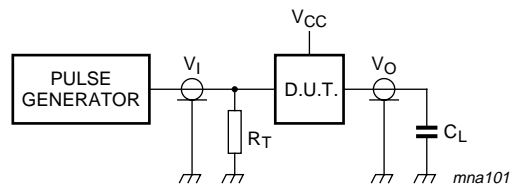
13. Waveforms



74AHC2G32: $V_M = 0.5 \times V_{CC}$; $V_i = \text{GND to } V_{CC}$.

74AHCT2G32: input $V_M = 1.5$ V and output $V_M = 0.5 \times V_{CC}$; $V_i = \text{GND to } 3.0$ V.

Fig 5. The input (nA and nB) to output (nY) propagation delays.



Definitions for test circuit:

C_L = Load capacitance including jig and probe capacitance (See [Section 12](#) for the value).

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

Fig 6. Load circuitry for switching times.

14. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

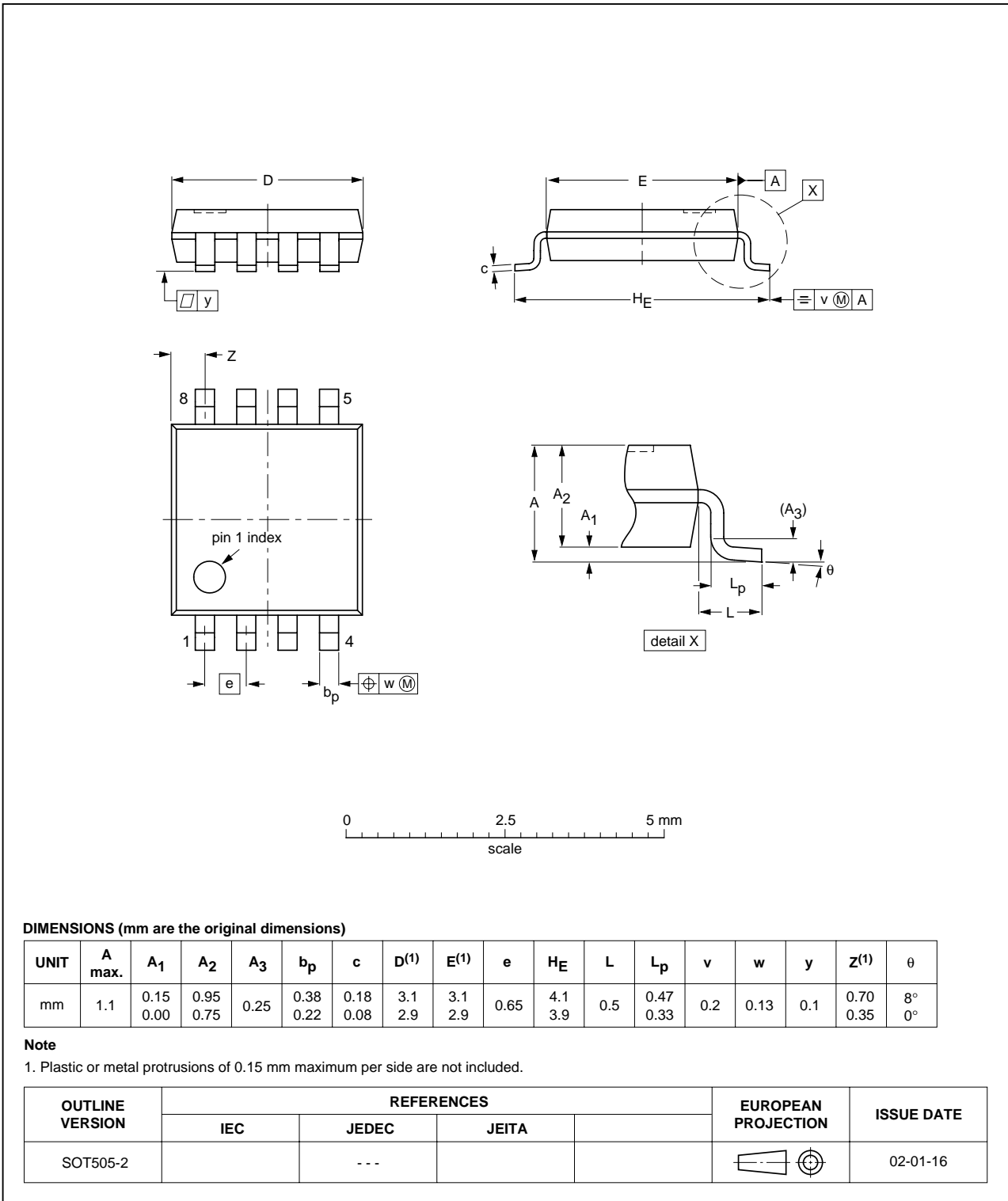


Fig 7. Package outline TSSOP8

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

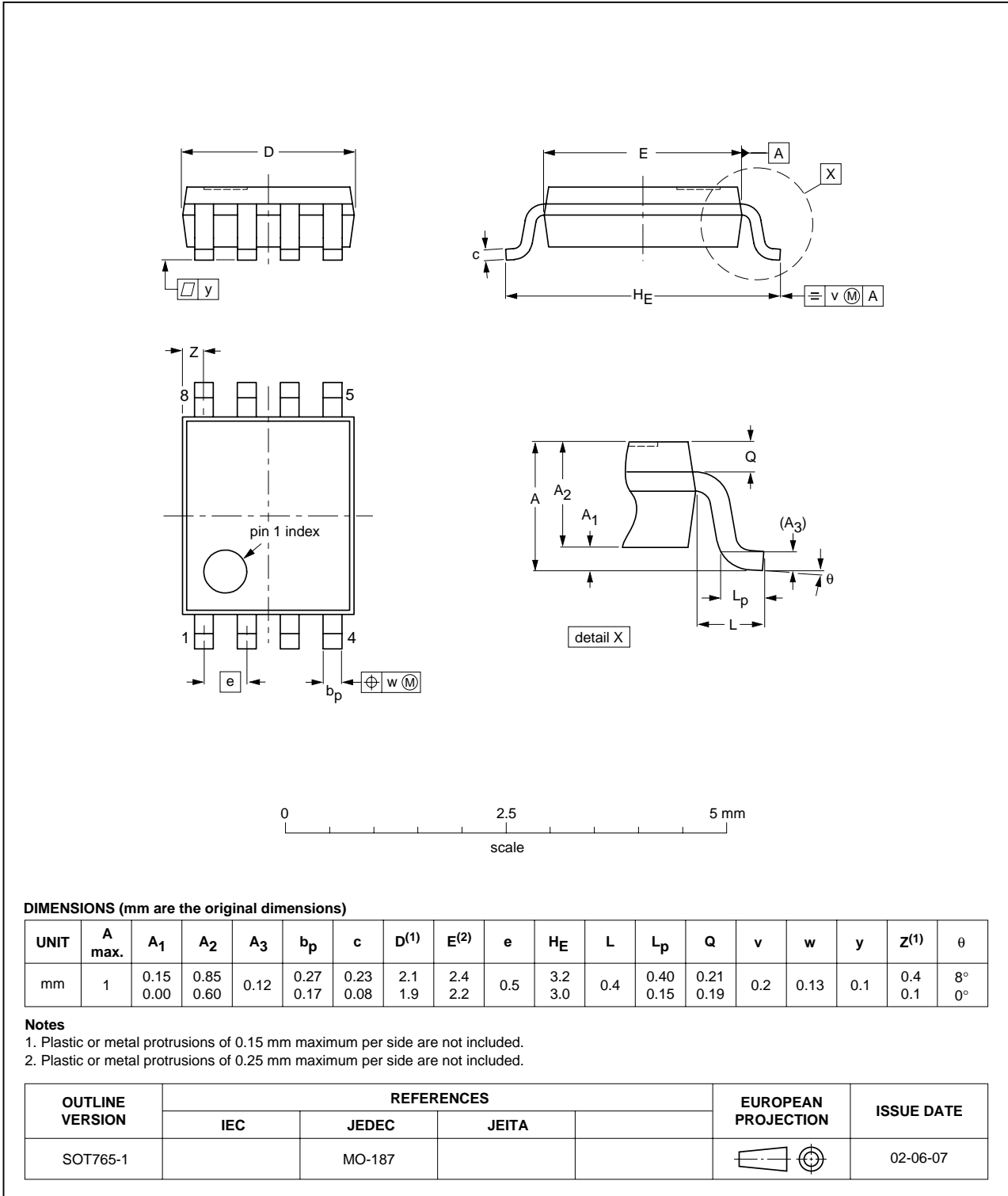


Fig 8. Package outline VSSOP8

15. Revision history

Table 12: Revision history

| Document ID | Release date | Data sheet status | Change notice | Order number | Supersedes |
|------------------|--------------|-------------------|---------------|----------------|------------|
| 74AHC_AHCT2G32_1 | 20040223 | Product data | - | 9397 750 12532 | - |

16. Data sheet status

| Level | Data sheet status ^[1] | Product status ^[2] ^[3] | Definition |
|-------|----------------------------------|--|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com

20. Contents

| | | |
|-----|--|----|
| 1 | General description | 1 |
| 2 | Features | 1 |
| 3 | Quick reference data | 1 |
| 4 | Ordering information | 2 |
| 5 | Marking | 2 |
| 6 | Functional diagram | 2 |
| 7 | Pinning information | 3 |
| 7.1 | Pinning | 3 |
| 7.2 | Pin description | 3 |
| 8 | Functional description | 4 |
| 8.1 | Function table | 4 |
| 9 | Limiting values | 4 |
| 10 | Recommended operating conditions | 4 |
| 11 | Static characteristics | 5 |
| 12 | Dynamic characteristics | 9 |
| 13 | Waveforms | 10 |
| 14 | Package outline | 12 |
| 15 | Revision history | 14 |
| 16 | Data sheet status | 15 |
| 17 | Definitions | 15 |
| 18 | Disclaimers | 15 |
| 19 | Contact information | 15 |



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